# **Graphene electronics**

# Johannes Svensson Nanoelectronics EITP05

# Outline

#### - Graphene production

- Mechanical exfoliation
- Epitaxial growth
- Chemical vapor deposition
- Transport characteristics
- High frequency performance
- Inducing a band gap
  - Nanoribbon
  - Bilayer graphene
  - Chemical modification
- Performance comparison (graphene / CNTs)
- Other electronic CNT/graphene devices

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### Mechanical exfoliation

- Rub graphite on substrate
- Use adhesive tape to peel off layers
- $100x100 \ \mu m$  flakes -> mainly for research
- Visible in optical microscope







# **Observing graphene**

- Optical microscope
- Atomic force microscopy
- TEM
- SEM
- Raman spectroscopy







#### Epitaxial growth on SiC

-Heat to 1550 °C to remove Si which will expose a graphene layer

-Need to remove "coupling" to substrate by e.g. hydrogen treatment





### Chemical vapor deposition



Kim et al. Nature 457, 706-710 (2009)

#### Chemical vapor deposition - result

- Mix of single and multilayered -  $\mu_e$ =3,700 cm<sup>2</sup>/Vs after transfer





### Large scale CVD production

- CVD on Cu foil
- 30 inch multilayer flake
- $30 \Omega/\Box$  at 90% transparency
- Better than ITO











Bae et al. Nature Nanotech. 5, 574–578 (2010)

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#### Transfer characteristics

- DOS decreases towards "Dirac" point.
- Finite conductance due to corrugations, charge impurities, disorder etc.
- No band gap -> poor on/off ratio
- Logic requires on/off > 3000 i.e. can not make digital circuits.



#### **Output characteristics**

- Low V<sub>DS</sub>: only holes in channel
- Intermediate V<sub>DS</sub>: channel pinched off at drain.
- High V<sub>DS</sub>: electrons close to drain. e/h crossover point moves into channel with increasing V<sub>DS</sub>



Drain-source voltage



# High mobility

- Exfoliated graphene
- Unsuspended flakes:  $\mu_e$ =2 000 30 000 cm<sup>2</sup>/Vs (substrate phonons)
- Supended and annealed flakes:  $\mu_e = 230\ 000\ cm^2/Vs$
- Scattering due to, phonons, impurities and edges



Bolotin et al. PRL 101, 096802 (2008)

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# High frequency device

- SiC grown graphene
- $f_T = 100 \text{ GHz for } L_g = 240 \text{ nm}$
- Large output conductance -> low f<sub>max</sub>





Lin et al. Science, 327, 662 (2010)

#### Graphene - nanowire device

- Dielectric lowers mobility
- Gate underlap: high source/drain access resistance reduce g<sub>m</sub>
- Gate overlap: increased paracitic capacitances
- Silicide nanowires with Al<sub>2</sub>O<sub>3</sub> shell on exfoliated graphene
- Self-aligned Pt contacts



#### Graphene - nanowire device performance

- g<sub>m</sub> improves after Pt
- $f_T = 300 \text{ GHz for } L_g = 144 \text{ nm}$
- Better than Si MOSFETs, similar to InP and GaAs HEMTs



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# Confinement of electron wavefunctions

- Make narrow ribbon to introduce band gap
- Fixed boundary conditions instead of periodic (CNT)
- Wavevectors  $k_{\perp} = n\pi/C$  with n=1,2,3... allowed
- Need width = CNT circumference / 2 to get same band gap



## Chemical exfoliation

- Intercalate sulfuric acid and nitric acid in graphite
- Heat to 1000°C -> few-layered graphene sheets.
- Sonication with polymer -> graphene nanoribbons









# Etching

- E-beam lithography and oxygen plasma etching
- Not narrow enough
- Diffcult to control edges



# Unzipping a CNT

Use oxygen plasma to remove layers of CNTs
Very delicate process -> no mass production



### Band gap vs GNR width

- Need 1 nm wide ribbons to get E<sub>g</sub>=1 eV
- Gap depends on edge structure



Schwierz, Nature Nanotech. 5, 487 (2010)

#### Mobility degradation

- Narrower -> Larger E<sub>g</sub> -> higher m<sup>\*</sup> -> lower mobility (as for CNTs)
- Graphene ribbons are worse than III-V materials



# Bilayer graphene

- Perpendicular electric field breaks symmetry in bilayer graphene.
- Band gap proportional to E-field.







 $k(Å^{-1})$ 





Oostinga et al. Nature Mat. 7, 151 - 157 (2007)

#### Double gated bilayer device

- Need to apply 120 V to get on/off = 100
- Difficult to use for integrated circuits
- Mobility is probably degraded



Xia et al. Nano Lett. 10, 715–718 (2010)

# Graphane

- Heat graphene in hydrogen -> graphane
- $sp^2 \rightarrow sp^3 \rightarrow remove conducting \pi$ -bonds and opening an energy gap
- Lose the linear band dispersion of graphene



Elias et al. Science, 323, 610-613 (2009)

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## Comparing CNT and graphene FETs

Graphene FETs	Carbon nanotubes FETs
No band gap gives poor on/off ratio, not for logic, maybe RF	Sufficient band gap for logic
Difficult to control edges which gives mobility degradation	No dangling bonds
Large area production possible	Need parallel CNTs to obtain high on-current and g <sub>m</sub>
Only one type of device	No control of metallic / semiconducting type

### NanoElectronics Roadmap for Europe

#### Recommendations for Carbon Nanotubes Develop solutions to at source/drain Develop solutions to Develop faster growing process induced by m-CNTs and doping fluctuation Develop compact models and design tools and evaluate the power-performance on real design con-

texts taking into account the physics of the device (quantum capacitance) and its parasitics.

### Benchmarking

- DC measurements: gate delay, energy delay product, subthreshold slope
- Large spread in results for CNTs
- Gate delay (CV/I) may be quite incorrect





#### CNT density and purity



Franklin, Nature 498, 443 (2013)

#### Graphene gate length scaling



# Comparing high frequency performance

- III-V materials are still better
- Need to reduce L<sub>g</sub> of CNT/graphene FET
- Need good saturation (low g<sub>d</sub>) to get high f<sub>max</sub>



# Why carbon electronics?

+ High mobility (long mfp, no surface roughness scattering, high carrier velocity)

- + High current density
- + Good electrostatics
- + Compatible with high-k dielectrics
- + Same electron/hole band structure
- + "cheap" starting materials

# Why not?

- Uncontrolled band gap
- Poor position control
- Unstable doping
- Difficult to mass produce

#### **Research Activity**

- Rapidly increasing # of publications
- Graphene > CNTs in 2011



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# Other applications

- supercapacitor electrodes
- memories
- **LEDs**
- photodiodes
- solar cells
- interconnects
- transparent electrodes
- **NEMS for mass sensing**
- **DNA** sequencing
- quantum computing
- spintronics
- **Conductive materials**



#### Space elevator

